

**PowerMOS transistor**

**BUK427-500A  
BUK427-500B**

T-39-11

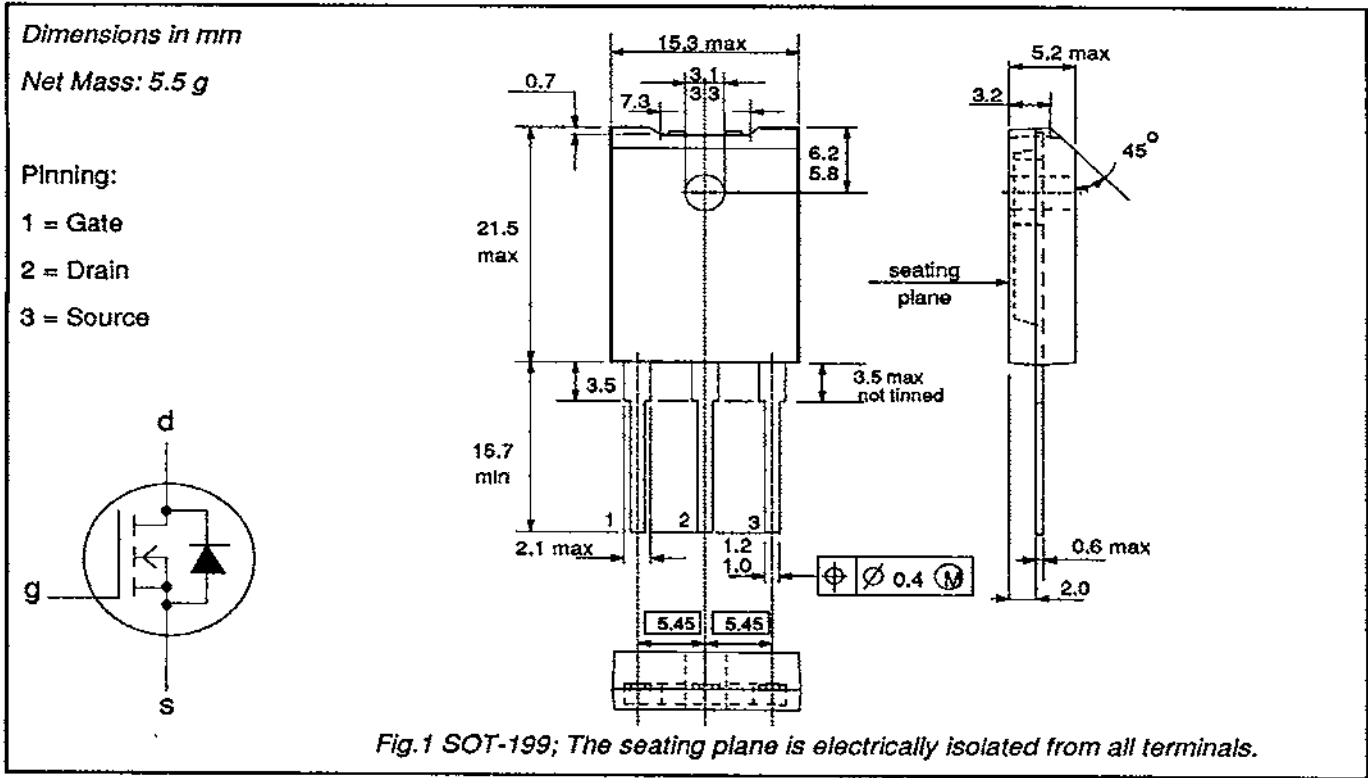
**GENERAL DESCRIPTION**

N-channel enhancement mode field-effect power transistor in a plastic full pack envelope. The device is intended for use in Switched Mode Power Supplies (SMPS), motor control, welding, DC/DC and AC/DC converters, and in general purpose switching applications.

**QUICK REFERENCE DATA**

SYMBOL	PARAMETER	MAX.	MAX.	UNIT
$V_{DS}$	Drain-source voltage	-500A	-500B	V
$I_D$	Drain current (DC)	5.6	4.8	A
$P_{tot}$	Total power dissipation	45	45	W
$R_{DS(ON)}$	Drain-source on-state resistance	0.6	0.8	$\Omega$

**MECHANICAL DATA**



- Notes**
1. Observe the general handling precautions for electrostatic-discharge sensitive devices (ESDs) to prevent damage to MOS gate oxide.
  2. Accessories supplied on request; refer to Mounting instructions for F-pack envelopes.

## PowerMOS transistor

**BUK427-500A**  
**BUK427-500B**

T-39-11

## RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.		UNIT
$V_{DS}$	Drain-source voltage	-	-	500		V
$V_{DGR}$	Drain-gate voltage	$R_{GS} = 20 \text{ k}\Omega$	-	500		V
$\pm V_{GS}$	Gate-source voltage	-	-	30		V
$I_D$	Drain current (DC)	$T_{hs} = 25 \text{ }^\circ\text{C}$	-	-500A	-500B	A
$I_D$	Drain current (DC)	$T_{hs} = 100 \text{ }^\circ\text{C}$	-	5.6	4.8	A
$I_{DM}$	Drain current (pulse peak value)	$T_{hs} = 25 \text{ }^\circ\text{C}$	-	3.5	3.0	A
				22	19.2	A
$P_{tot}$	Total power dissipation	$T_{hs} = 25 \text{ }^\circ\text{C}$	-	45		W
$T_{sig}$	Storage temperature	-	-55	150		$^\circ\text{C}$
$T_j$	Junction Temperature	-	-	150		$^\circ\text{C}$

## THERMAL RESISTANCES

From junction to heatsink	with heatsink compound	$R_{th(j-hs)} = 2.8 \text{ K/W}$
From junction to ambient	-	$R_{th(j-a)} = 35 \text{ K/W}$

## STATIC CHARACTERISTICS

 $T_{hs} = 25 \text{ }^\circ\text{C}$  unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}; I_D = 0.25 \text{ mA}$	500	-	-	V
$V_{GS(TO)}$	Gate threshold voltage	$V_{DS} = V_{GS}; I_D = 1 \text{ mA}$	2.1	3.0	4.0	V
$I_{DSS}$	Zero gate voltage drain current	$V_{DS} = 500 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 25 \text{ }^\circ\text{C}$	-	2	20	$\mu\text{A}$
$I_{DSS}$	Zero gate voltage drain current	$V_{DS} = 500 \text{ V}; V_{GS} = 0 \text{ V}; T_j = 125 \text{ }^\circ\text{C}$	-	0.1	1.0	mA
$I_{GSS}$	Gate source leakage current	$V_{GS} = \pm 30 \text{ V}; V_{DS} = 0 \text{ V}$	-	10	100	nA
$R_{DS(ON)}$	Drain-source on-state resistance	$V_{GS} = 10 \text{ V}; I_D = 6.5 \text{ A}$	-	0.55	0.6	$\Omega$
		BUK427-500A	-	0.7	0.8	$\Omega$
		BUK427-500B	-			

## DYNAMIC CHARACTERISTICS

 $T_{hs} = 25 \text{ }^\circ\text{C}$  unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$g_{fs}$	Forward transconductance	$V_{DS} = 25 \text{ V}; I_D = 6.5 \text{ A}$	5.0	8.0	-	S
$C_{iss}$	Input capacitance	$V_{GS} = 0 \text{ V}; V_{DS} = 25 \text{ V}; f = 1 \text{ MHz}$	-	1500	1800	pF
$C_{oss}$	Output capacitance		-	170	270	pF
$C_{rss}$	Feedback capacitance		-	70	120	pF
$t_{don}$	Turn-on delay time	$V_{DD} = 30 \text{ V}; I_D = 2.8 \text{ A};$	-	20	40	ns
$t_r$	Turn-on rise time	$V_{GS} = 10 \text{ V}; R_{GS} = 50 \text{ } \Omega;$	-	60	90	ns
$t_{doff}$	Turn-off delay time	$R_{gen} = 50 \text{ } \Omega$	-	200	250	ns
$t_f$	Turn-off fall time		-	75	90	ns
$L_d$	Internal drain inductance	Measured from drain lead 6 mm from package to centre of die	-	5	-	nH
$L_s$	Internal source inductance	Measured from source lead 6 mm from package to source bond pad	-	12.5	-	nH

## ISOLATION

 $T_{hs} = 25 \text{ }^\circ\text{C}$  unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$V_{isol}$	Repetitive peak voltage from all three terminals to external heatsink	R.H. $\leq 65 \%$ ; clean and dustfree	-	-	2500	V
$C_{isol}$	Capacitance from T2 to external heatsink	$f = 1 \text{ MHz}$	-	22	-	pF

PowerMOS transistor

BUK427-500A  
BUK427-500B

T-39-11

REVERSE DIODE RATINGS AND CHARACTERISTICS

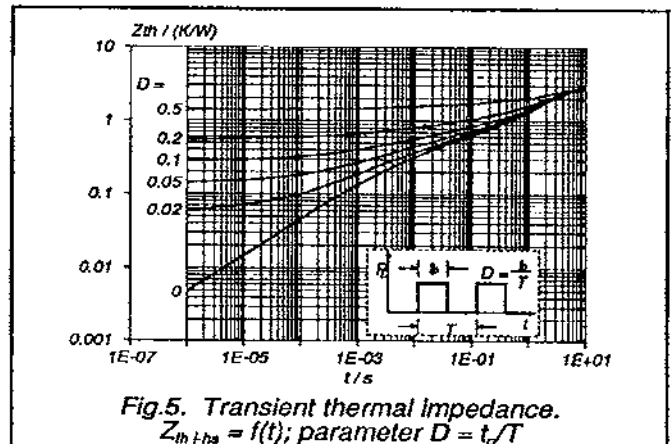
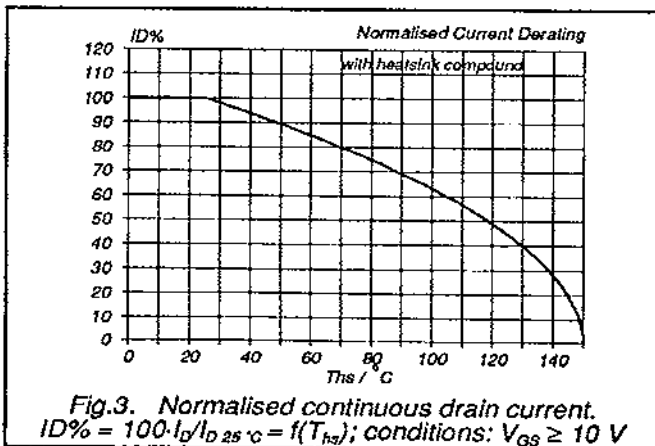
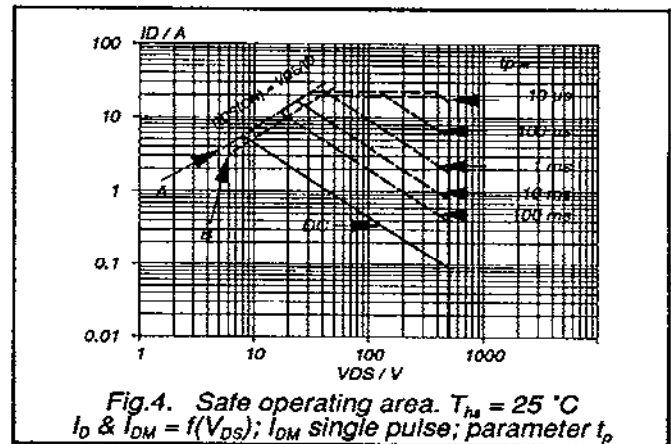
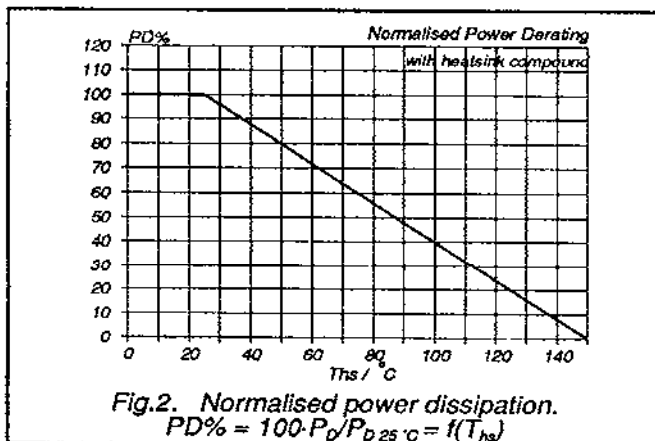
$T_{hs} = 25\text{ }^{\circ}\text{C}$  unless otherwise specified

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$I_{DR}$	Continuous reverse drain current	-	-	-	5.6	A
$I_{DRM}$	Pulsed reverse drain current	-	-	-	22	A
$V_{SD}$	Diode forward voltage	$I_F = 5.6\text{ A}; V_{GS} = 0\text{ V}$	-	1.1	1.4	V
$t_{rr}$	Reverse recovery time	$I_F = 5.6\text{ A}; -di_F/dt = 100\text{ A}/\mu\text{s}; V_{GS} = 0\text{ V}; V_R = 100\text{ V}$	-	500	-	ns
$Q_{rr}$	Reverse recovery charge	$I_F = 5.6\text{ A}; -di_F/dt = 100\text{ A}/\mu\text{s}; V_{GS} = 0\text{ V}; V_R = 100\text{ V}$	-	6.0	-	$\mu\text{C}$

AVALANCHE RATING

$T_{hs} = 25\text{ }^{\circ}\text{C}$  unless otherwise specified

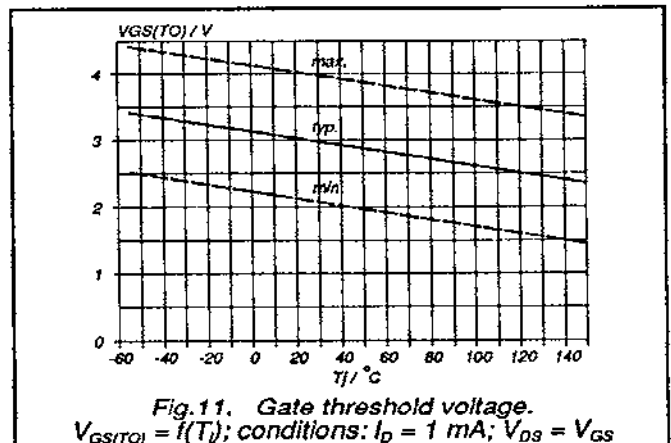
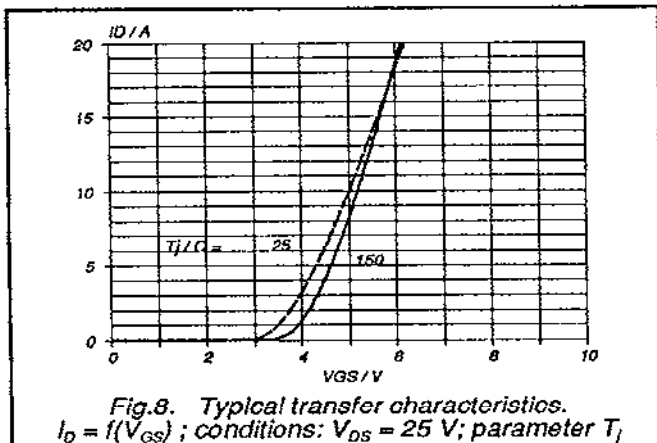
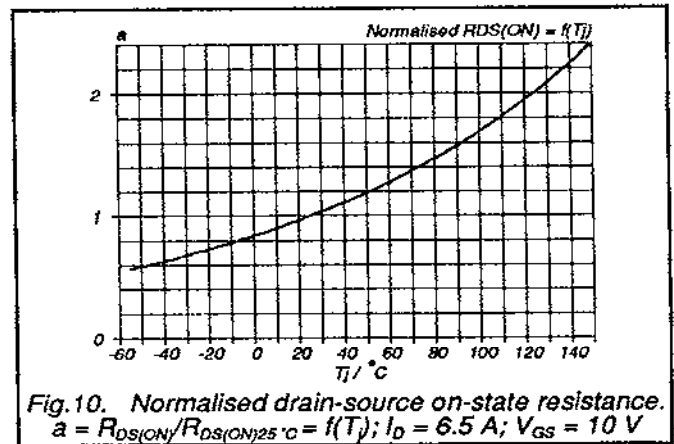
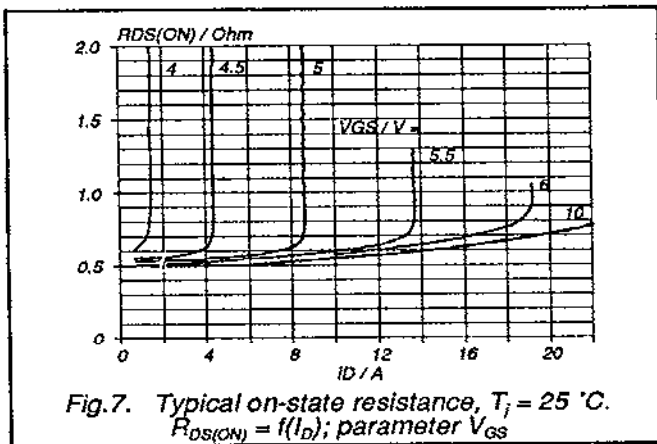
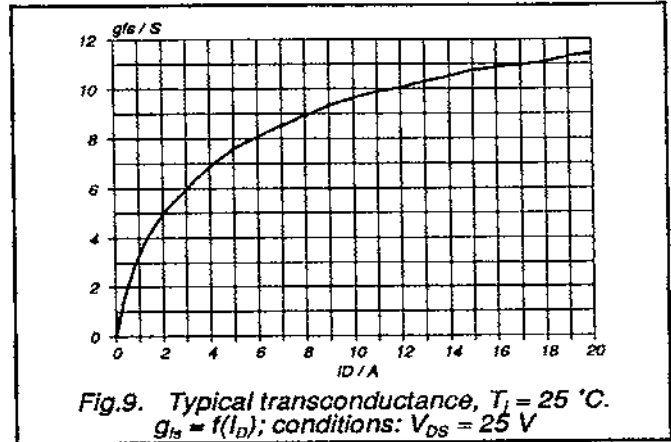
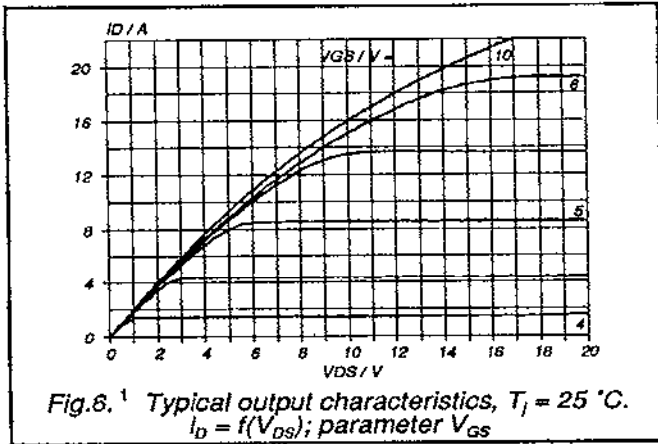
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$W_{DSS}$	Drain-source non-repetitive unclamped inductive turn-off energy	$I_D = 10\text{ A}; V_{DD} \leq 250\text{ V}; V_{GS} = 10\text{ V}; R_{GS} = 50\ \Omega$	-	-	500	mJ



PowerMOS transistor

BUK427-500A  
BUK427-500B

T-39-11



PowerMOS transistor

BUK427-500A  
BUK427-500B

T-39-11

